

## MOS FIELD EFFECT TRANSISTOR

2SK3356

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK3356 is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE		
2SK3356	TO-3P		

### **FEATURES**

- Super low on-state resistance:
- ★ RDS(on)1 =  $8.0 \text{ m}\Omega$  MAX. (Vgs = 10 V, ID = 38 A)
- ★ RDS(on)2 =  $12 \text{ m}\Omega$  MAX. (Vgs = 4 V, ID = 38 A)
- ★ Low Ciss: Ciss = 6300 pF TYP.
  - Built-in gate protection diode

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

	Drain to Source Voltage	V <sub>DSS</sub>	60	V
	Gate to Source Voltage	VGSS(AC)	±20	V
	Drain Current (DC)	I <sub>D(DC)</sub>	±75	Α
	Drain Current (pulse) Note1	D(pulse)	±300	Α
*	Total Power Dissipation (Tc = 25°C)	Рт	130	W
	Total Power Dissipation (T <sub>A</sub> = 25°C)	Рт	3.0	W
	Channel Temperature	Tch	150	°C
	Storage Temperature	$T_{stg}$	-55 to +150	°C
*	Single Avalanche Current Note2	las	55	Α
*	Single Avalanche Energy Note2	Eas	302	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty cycle  $\leq$  1 %

**2.** Starting Tch = 25 °C, Rg = 25  $\Omega$ , Vgs = 20 V  $\rightarrow$  0 V

### THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	0.93	°C/W
Channel to Ambient	Rth(ch-A)	41.7	°C/W

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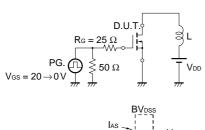
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

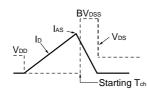


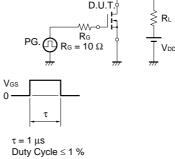
## **★** ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 38 A		6.3	8.0	mΩ
	RDS(on)2	Vgs = 4 V, ID = 38 A		8.0	12	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 38 A	35	57		S
Drain Leakage Current	Ipss	Vps = 60 V, Vgs = 0 V			10	μΑ
Gate to Source Leakage Current	lgss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	Vps = 10 V, Vgs = 0 V, f = 1 MHz		6300		pF
Output Capacitance	Coss			1000		pF
Reverse Transfer Capacitance	Crss			490		pF
Turn-on Delay Time	td(on)	$I_D = 38 \text{ A}, V_{GS(on)} = 10 \text{ V}, V_{DD} = 30 \text{ V},$		90		ns
Rise Time	tr	$R_G = 10 \Omega$		1100		ns
Turn-off Delay Time	td(off)			300		ns
Fall Time	tf			400		ns
Total Gate Charge	QG	ID = 75 A , VDD = 48 V, VGS = 10 V		106		nC
Gate to Source Charge	Qgs			20		nC
Gate to Drain Charge	Q <sub>GD</sub>			30		nC
Body Diode Forward Voltage	VF(S-D)	IF = 75 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 75 A, Vgs = 0 V,		55		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		100		nC

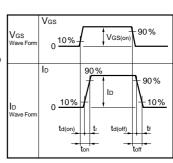
## **TEST CIRCUIT 1 AVALANCHE CAPABILITY**







**TEST CIRCUIT 2 SWITCHING TIME** 

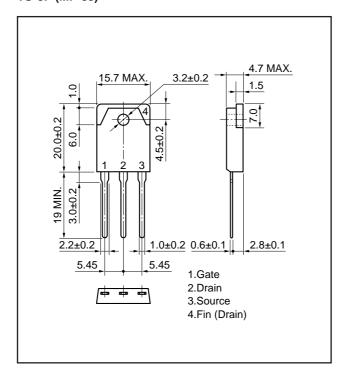


#### **TEST CIRCUIT 3 GATE CHARGE**

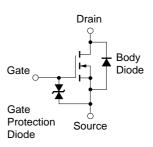
$$\begin{array}{c|c} D.U.T. \\ \hline \\ l_G = 2 \text{ mA} \\ \hline \\ W \\ \hline \end{array} \\ \begin{array}{c} R_L \\ \hline \\ V_{DD} \\ \end{array}$$

## PACKAGE DRAWING (Unit: mm)

## TO-3P (MP-88)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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